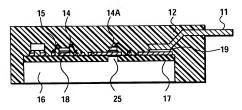


FIG.1B

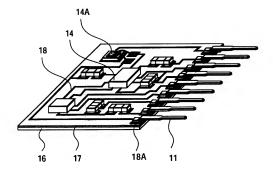


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FIG.2



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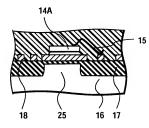


FIG.3B

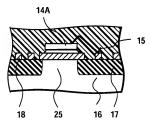
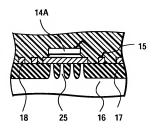
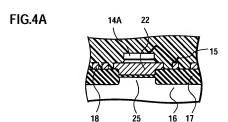
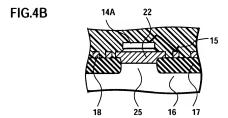
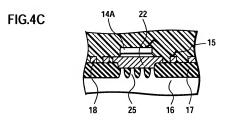


FIG.3C









SAME

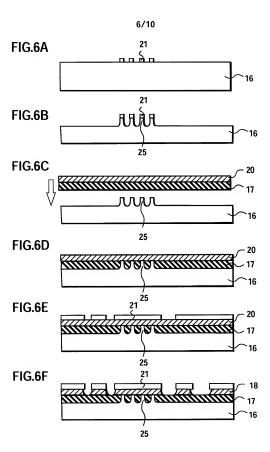
5/10 21 FIG.5A 21 FIG.5B FIG.5C - 20 25 FIG.5D <u>2</u>5 21 FIG.5E 17 **25** FIG.5F

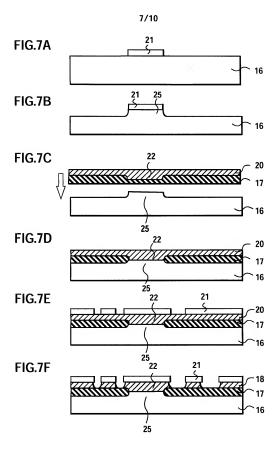
25

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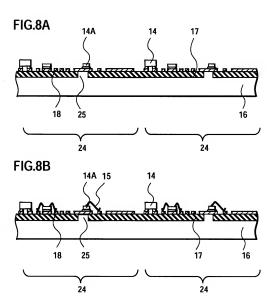
SAME





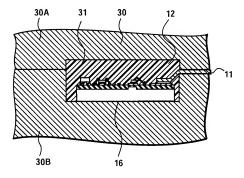
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FIG.9



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